Specifications for Approval

Cu	ustomer Part N	0.:				
Inl	here Part No.:	S2012CHAMT-001				
Pa	art Name: 2012	!橙光 LED				
Sp	Spec Issue Date: 2018-07-12					
Re	evision No.: A					
=======================================	=========	=======================================	=======================================			
■ Sample ■ Electrical Cha		g information for your a spection Record ve Internal (pproval: ■LED Dimension Circuit Diagram			
Prepared by: Lily Date: 2018-07-1	y	Checked by: Tom Date: 2018-07-12	Approved by: W Date: 2018-07-			
Customer Opini		on:	=======================================			



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Features

2.0mm x 1.25mm SMD LED, 0.8mm thickness

Low power consumption

Wide view angle

Package: 3000pcs/reel

RoHS Compliant

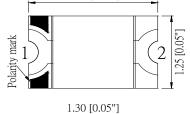
Applications

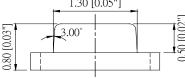
Ideal for back light and indicator

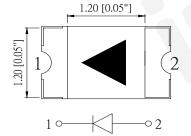
Various colors and lens types available

Package outlines

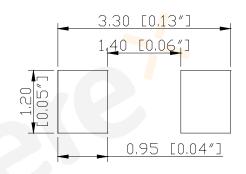
2.00 [0.08"]







Recommend Pad Layout





Part No.	Emitted color	Dice	Lens color
S2012CHAMT-001	Orange	AlGaInP	Water transparent

Notes:

All dimensions are in millimeters (inches);

Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

Part No.: S2012CHAMT-001 Prepared by: Lily Rev.: A Checked by: Tom

Absolute Maximum Ratings (Ta=25°C)

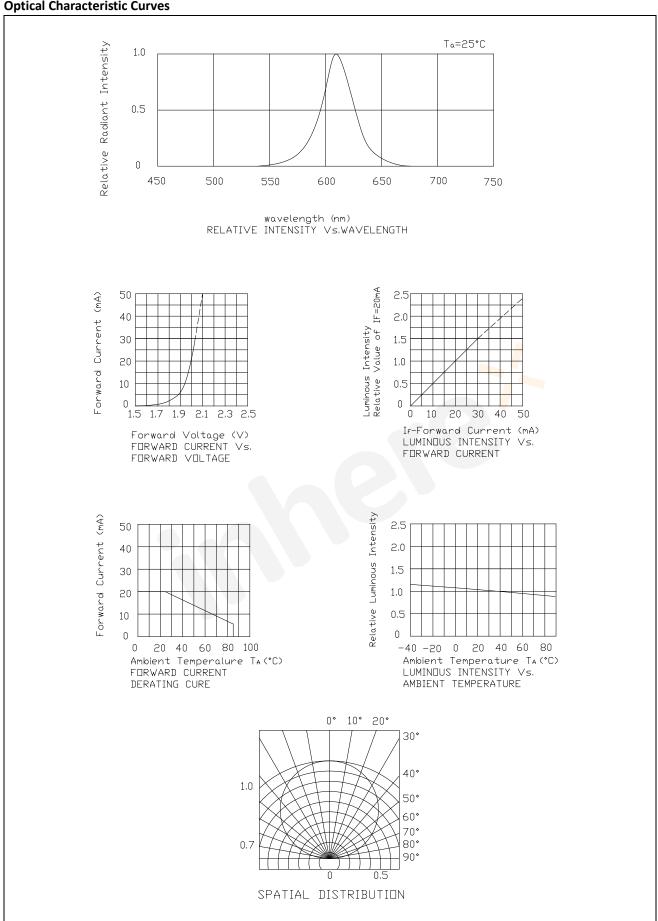
Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	72	mW
Operating temperature	Тор	-40 ~+80	°C
Storage temperature	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125	mA

Electro-Optical Characteristics (Ta=25°C)

	Test Sym Condition		Value			
Parameter		Symbol	Min	Тур	Max	Unit
Wavelength at peak emission	If=20mA	λр		610		nm
Spectral half bandwidth	If=20mA	Δλ		18		nm
Dominant wavelength	If=20mA	λd	600		610	nm
Forward voltage	If=20mA	Vf	1.8		2.4	V
Luminous intensity	If=20mA	lv	100	160		mcd
Viewing angle at 50% lv	If=10mA	2 θ 1/2		120		Deg
Reverse current	Vr=5V	lr			10	μΑ

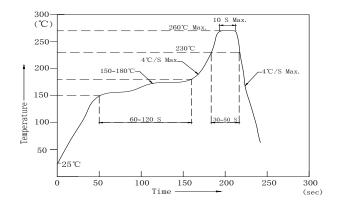
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Optical Characteristic Curves



Reflow Profile

■ Reflow Temp/Time



Notes:

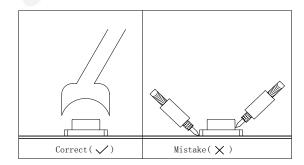
- 1. We recommend the reflow temperature 245 $^{\circ}$ C (±5 $^{\circ}$ C).the maximum soldering temperature should be limited to 260 $^{\circ}$ C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is \leq 5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C \rightarrow -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350°C.

■Rework

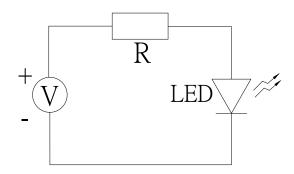
- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C}^{\sim}30^{\circ}\text{C}$ and <30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at \leq 20 R.H. with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- $3.1 60\pm3$ °C x ($12\sim24$ hrs) and <5%RH, taped reel type
- 3.2 100±3°C x (45min~1hr), bulk type
- 3.3 130±3°C x (15~30min), bulk type

Test Items and Results of Reliability

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Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5 °C ,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5°C 30±1min ↑→(25°C/5±1min)↓ 100±5°C 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=- 40 ± 5 $^{\circ}$ C \sim 100 ± 5 $^{\circ}$ C, 15 ± 1 min dwell	Ta=-40±5℃~100±5℃,		0/22
High Humidity High Temp. Cycling	Ta=30±5°C ∼65±5°C, 90±5%RH,24hrs/1cycle GB/T 2423.4-20		10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5°C,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5 °C,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5°C,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5˚C ,@20mA, ψ(%)=25%RH~55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5˚C ,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
7	1.8	1.9	
8	1.9	2.0	
9	2.0	2.1	
А	2.1	2.2	V
В	2.2	2.3	
С	2.3	2.4	

Luminous Intensity Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
1	100	125	
J	100	123	
K	125	160	
L	160	200	mcd
М	200	250	
N	250		

Dominant wavelength Rank Combination (IF=20mA)

offiniant wavelength rank combination (n=20mA)				
Rank	Min.	Max.	Unit	
Oa	600	602		
Ob	602	604		
Oc	604	606	nm	
Od	606	608		
Oe	608	610		

Group Name on Label (Example DATA: 9KOb 20)

DATA: 9KOb 20	Vf(V)	lv (mcd)	λd (nm)	Test Condition
9 → K → Ob → 20	2.0~2.1	125~160	602~604	IF=20mA

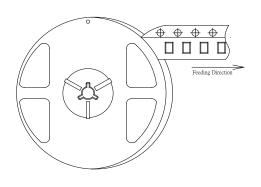
Notes:

- 1.The tolerance of luminous intensity (Iv)is $\pm 15\,\%$.
- 2. The tolerance of dominant wavelength is ± 1 nm.
- 3. This specification is preliminary.
- 4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

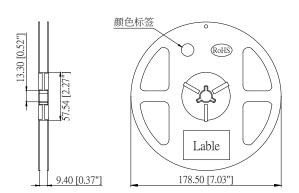
Part No.: S2012CHAMT-001 Prepared by: Lily Rev.: A Checked by: Tom

2012 Series SMD Chip LED Lamps Packaging Specifications

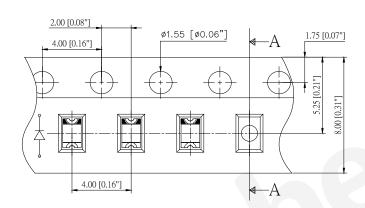
Feeding Direction

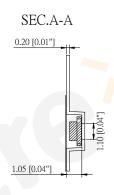


Dimensions of Reel (Unit: mm)

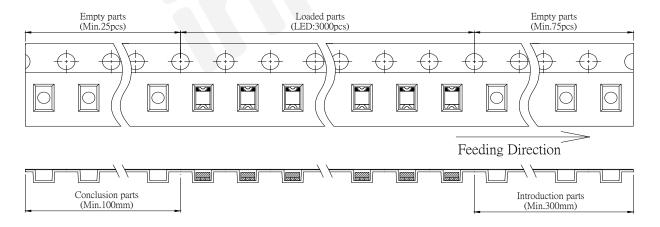


• Dimensions of Tape (Unit: mm)





Arrangement of Tape



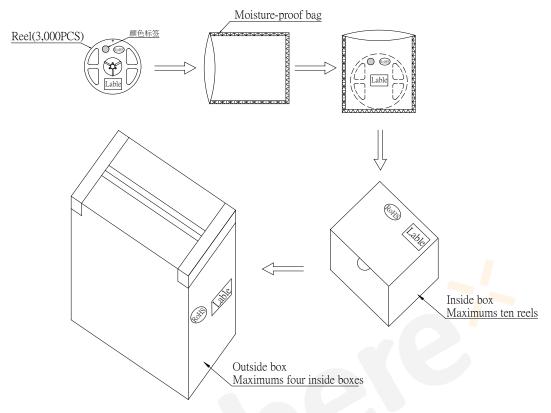
Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 3,000pcs/Reel.

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2012 Series SMD Chip LED Lamps Packaging Specifications

Packaging specifications



Notes:

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 30,000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x 260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.

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